# 2SC5121

### Silicon NPN triple diffusion planar type

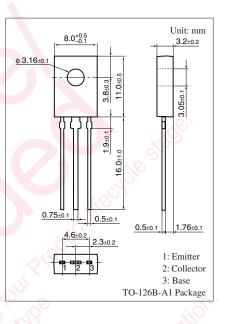
#### For general amplification

#### Features

- High collector-base voltage (Emitter open)  $V_{CBO}$
- $\bullet$  High collector-emitter voltage (Base open)  $V_{\mbox{CEO}}$
- Small collector output capacitance (Common base, input open circuited) C<sub>ob</sub>
- TO-126B package which requires no insulation plate for installation to the heat sink

| Absolute Maximum Ratings $T_a = 25^{\circ}C$ |                  |             |      |  |  |  |  |
|--|------------------|-------------|------|--|--|--|--|
| Parameter                                    | Symbol           | Rating      | Unit |  |  |  |  |
| Collector-base voltage (Emitter open)        | V <sub>CBO</sub> | 400         | V    |  |  |  |  |
| Collector-emitter voltage (Base open)        | V <sub>CEO</sub> | 400         | v    |  |  |  |  |
| Emitter-base voltage (Collector open)        | V <sub>EBO</sub> | 7           | V    |  |  |  |  |
| Collector current                            | I <sub>C</sub>   | 70          | mA   |  |  |  |  |
| Peak collector current                       | I <sub>CP</sub>  | 100         | mA   |  |  |  |  |
| Collector power dissipation                  | P <sub>C</sub>   | 1.2         | W    |  |  |  |  |
| Junction temperature                         | Tj               | 150         | °C   |  |  |  |  |
| Storage temperature                          | T <sub>stg</sub> | -55 to +150 | °C   |  |  |  |  |
|  |                  |             |      |  |  |  |  |

#### Absolute Maximum Ratings T<sub>a</sub> = 25°C

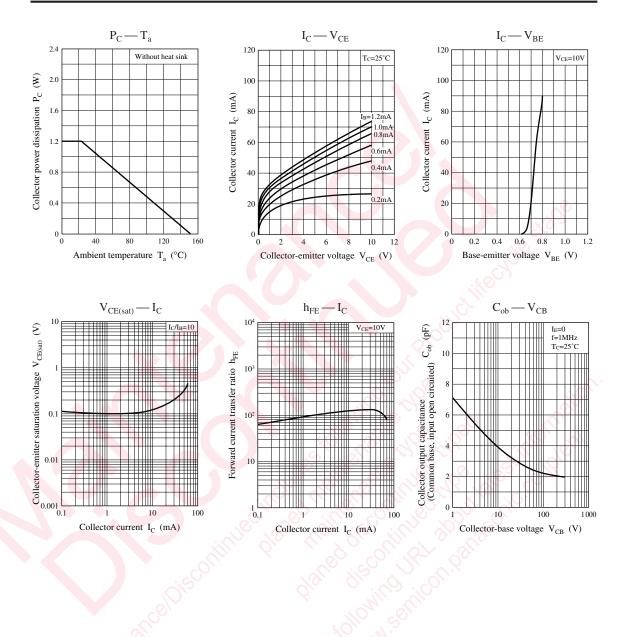


#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter                                    | Symbol               | Conditions   | Min        | Тур | Max | Unit |
|--|----------------------|--|------------|-----|-----|------|
| Collector-emitter voltage (Base open)        | V <sub>CEO</sub>     | $I_{\rm C} = 100 \ \mu \rm{A}, \ I_{\rm B} = 0$                    | 400        | S   |     | V    |
| Emitter-base voltage (Collector open)        | V <sub>EBO</sub>     | $I_{\rm E} = 1 \ \mu A, I_{\rm C} = 0$                             | 7          | 0   |     | V    |
| Collector-base cutoff current (Emitter open) | I <sub>CBO</sub>     | $V_{CB} = 300 \text{ V}, I_E = 0$                                  | $\sqrt{2}$ |     | 10  | μΑ   |
| Collector-emitter cutoff current (Base open) | I <sub>CEO</sub>     | $V_{CE} = 380 \text{ V}, I_B = 0, T_a = 80^{\circ}\text{C}$        |            |     | 10  | μΑ   |
| Forward current transfer ratio *             | h <sub>FE</sub>      | $V_{CE} = 10 \text{ V}, I_C = 5 \text{ mA}$                        | 30         |     | 100 |      |
| Collector-emitter saturation voltage *       | V <sub>CE(sat)</sub> | $I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$                          |            |     | 1.2 | V    |
| Transition frequency                         | f <sub>T</sub>       | $V_{CB} = 10 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$ | 50         | 80  |     | MHz  |
| Collector output capacitance                 | C <sub>ob</sub>      | $V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$                |            | 4   | 8   | pF   |
| (Common base, input open circuited)          |                      |  |            |     |     |      |

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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